# **MOSFET** – N-Channel, SUPERFET II, FRFET

650 V, 20.6 A, 190 mΩ

# FCH190N65F

### Description

SUPERFET<sup>®</sup> II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET<sup>®</sup> MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 168 \text{ m}\Omega$  (Typ.)
- Ultra Low Gate Charge (Typ.  $Q_g = 60 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. Coss(eff.) = 304 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

### Applications

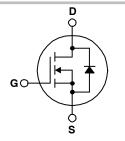
- LCD / LED / PDP TV
- Solar Inverter
- Telecom, Server Power Supplies
- AC-DC Power Supply



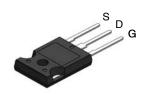
# **ON Semiconductor®**

### www.onsemi.com

V <sub>DS</sub>	V <sub>DS</sub> R <sub>DS(ON)</sub> MAX	
650 V	190 mΩ @ 10 V	20.6 A

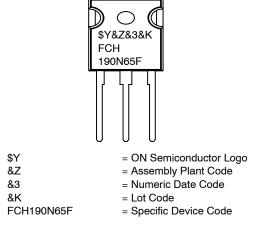


N-CHANNEL MOSFET



TO-247-3LD CASE 340CH

#### MARKING DIAGRAM



### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	FCH190N65F-F155	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V
V <sub>GSS</sub>	Gate to Source Voltage –DC		±20	V
		-AC (f > 1 Hz)	±30	
Ι <sub>D</sub>	Drain Current	–Continuous (T <sub>C</sub> = 25°C)	20.6	А
		–Continuous (T <sub>C</sub> = 100°C)	13.1	
I <sub>DM</sub>	Drain Current	-Pulsed (Note 1)	61.8	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		400	mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		4.0	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		2.1	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	208	W
		-Derate Above 25°C	1.67	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to + 150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8 fro	300	°C	

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2.  $I_{AS} = 4 \text{ A}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^{\circ}\text{C}$ 3.  $I_{SD} \le 10 \text{ A}$ , di/dt  $\le 200 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le 380 \text{ V}$ , Starting  $T_J = 25^{\circ}\text{C}$ .

### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FCH190N65F-F155	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### PACKAGE MARKING AND ORDERING INFORMATION

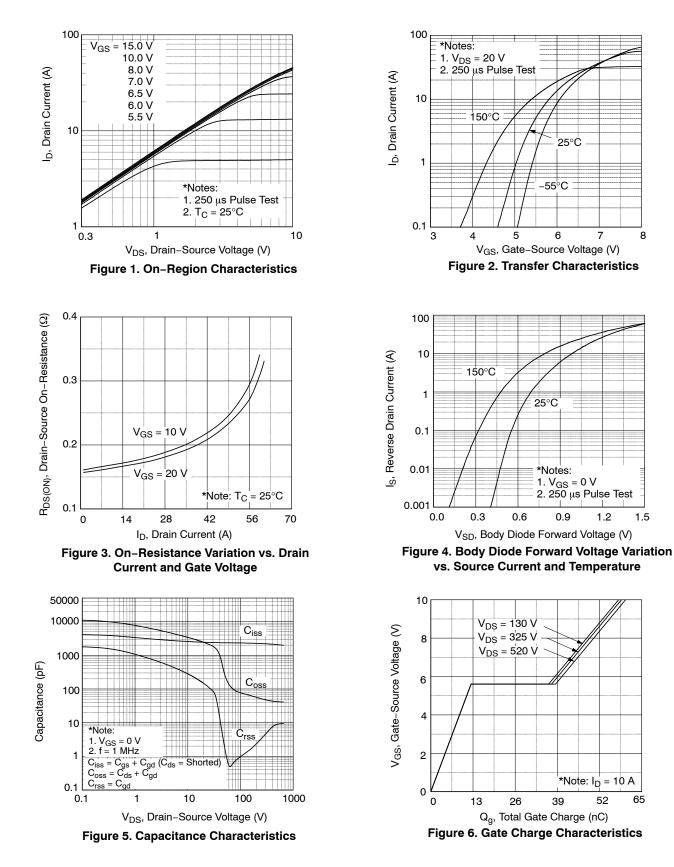
Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH190N65F-F155	FCH190N65F	TO-247-3LD	Tube	N/A	N/A	30 Units

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

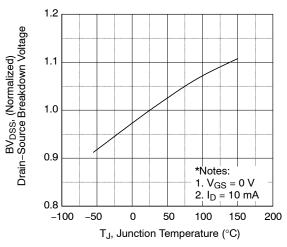
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 10 mA, $T_J$ = 25°C	650	-	-	V
		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$	700	-	-	
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to 25°C	-	0.72	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		$V_{DS}$ = 520 V, $V_{GS}$ = 0 V, $T_{C}$ = 125°C	-	60	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARAG	CTERISTICS	·				
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2 \text{ mA}$	3	-	5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	168	190	mΩ
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10 A	-	18	-	S
OYNAMIC C	HARACTERISTICS	•			•	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V,	-	2425	3225	pF
C <sub>oss</sub>	Output Capacitance	f = 1 MHz	-	78	104	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		_	0.68	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	44	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	-	304	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V		-	60	78	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		-	12	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller"Charge		-	25	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω
SWITCHING	CHARACTERISTICS	•		•		
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 380 V, I <sub>D</sub> = 10 A,	-	25	60	ns
tr	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω (Note 4)	-	11	32	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	62	134	ns
t <sub>f</sub>	Turn-Off Fall Time		_	4.2	18	ns
RAIN-SOU	RCE DIODE CHARACTERISTICS	•		•		
IS	Maximum Continuous Drain to Source Diode Forward Current		-	_	20.6	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	61.8	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 10 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 10 A,	-	105	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/µs	_	515	_	nC

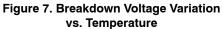
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

### **TYPICAL PERFORMANCE CHARACTERISTICS**



### TYPICAL PREFORMANCE CHARACTERISTICS (continued)





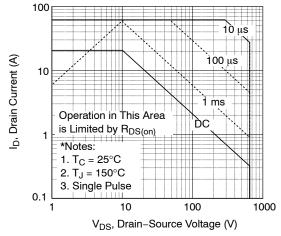


Figure 9. Maximum Safe Operating Area

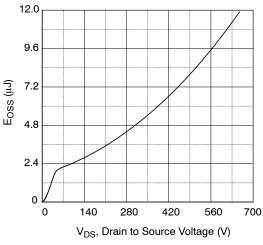


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

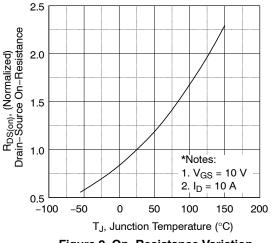


Figure 8. On–Resistance Variation vs. Temperature

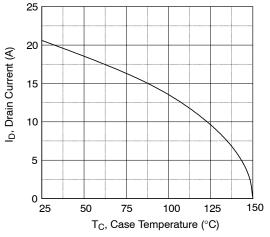
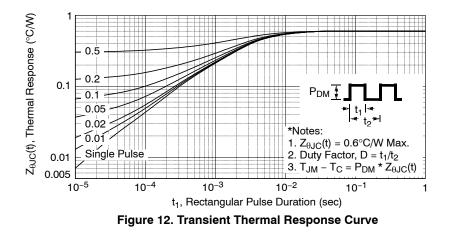


Figure 10. Maximum Drain Current vs. Case Temperature

# TYPICAL PERFORMANCE CHARACTERISTICS (continued)



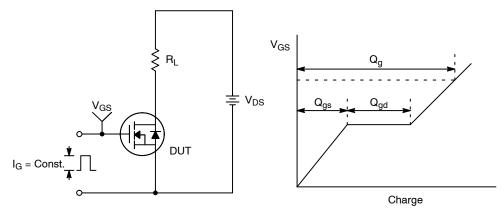


Figure 13. Transient Thermal Response Curve

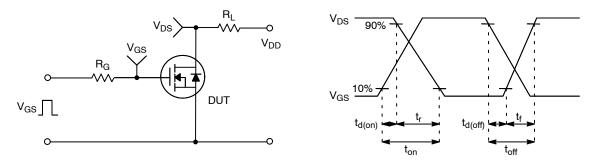


Figure 14. Resistive Switching Test Circuit & Waveforms

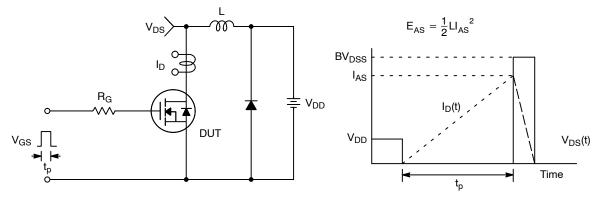


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

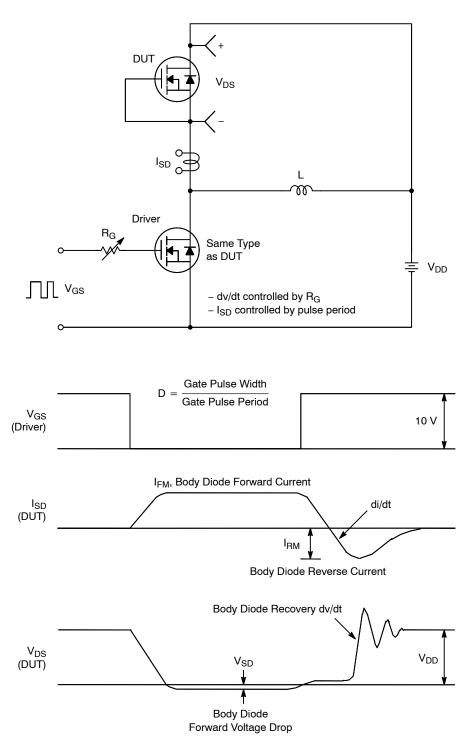
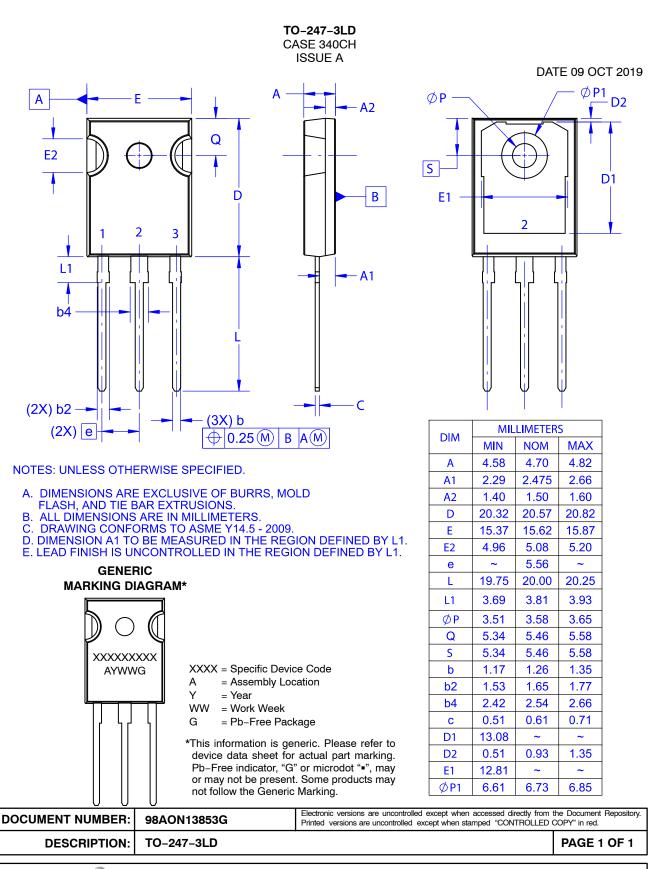


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

FRFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

SUPERFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>